

## General Description

These P-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

## Features

-30V, -9A,  $R_{DS(ON)} = 15m\Omega @ V_{GS} = -10V$

Fast switching

Green Device Available

Suit for -4.5V Gate Drive Applications

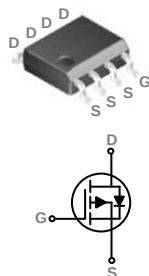
## Applications

MB / VGA / Vcore

POL Applications

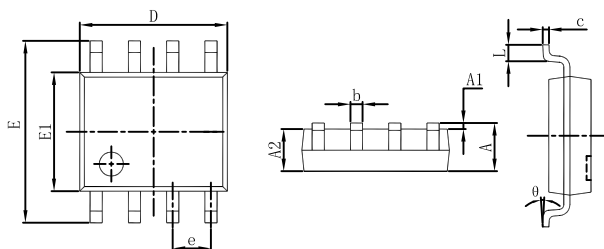
Load Switch

LED Application



| BVDSS | RDSON | ID  |
|-------|-------|-----|
| -30V  | 15mΩ  | -9A |

## SOP-8



| Symbol | Dimensions In Millimeters |       | Dimensions In Inches |       |
|--------|---------------------------|-------|----------------------|-------|
|        | Min                       | Max   | Min                  | Max   |
| A      | 1.350                     | 1.750 | 0.053                | 0.069 |
| A1     | 0.100                     | 0.250 | 0.004                | 0.010 |
| A2     | 1.350                     | 1.550 | 0.053                | 0.061 |
| b      | 0.330                     | 0.510 | 0.013                | 0.020 |
| c      | 0.170                     | 0.250 | 0.007                | 0.010 |
| D      | 4.800                     | 5.000 | 0.189                | 0.197 |
| e      | 1.270 (BSC)               |       | 0.050 (BSC)          |       |
| E      | 5.800                     | 6.200 | 0.228                | 0.244 |
| E1     | 3.800                     | 4.000 | 0.150                | 0.157 |
| L      | 0.400                     | 1.270 | 0.016                | 0.050 |
| θ      | 0°                        | 8°    | 0°                   | 8°    |

## Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

| Symbol    | Parameter                                              | Rating     | Units               |
|-----------|--------------------------------------------------------|------------|---------------------|
| $V_{DS}$  | Drain-Source Voltage                                   | -30        | V                   |
| $V_{GS}$  | Gate-Source Voltage                                    | $\pm 20$   | V                   |
| $I_D$     | Drain Current – Continuous ( $T_c=25^\circ\text{C}$ )  | -9         | A                   |
|           | Drain Current – Continuous ( $T_c=100^\circ\text{C}$ ) | -5.1       | A                   |
| $I_{DM}$  | Drain Current – Pulsed <sup>1</sup>                    | -32        | A                   |
| $P_D$     | Power Dissipation ( $T_c=25^\circ\text{C}$ )           | 2.1        | W                   |
|           | Power Dissipation – Derate above $25^\circ\text{C}$    | 0.017      | W/ $^\circ\text{C}$ |
| $T_{STG}$ | Storage Temperature Range                              | -55 to 150 | $^\circ\text{C}$    |
| $T_J$     | Operating Junction Temperature Range                   | -55 to 150 | $^\circ\text{C}$    |

## Thermal Characteristics

| Symbol          | Parameter                              | Typ. | Max. | Unit               |
|-----------------|----------------------------------------|------|------|--------------------|
| $R_{\theta JA}$ | Thermal Resistance Junction to ambient | ---  | 60   | $^\circ\text{C/W}$ |

# FDS4435

## Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

### Off Characteristics

| Symbol                              | Parameter                                 | Conditions                                                          | Min. | Typ.  | Max. | Unit |
|-------------------------------------|-------------------------------------------|---------------------------------------------------------------------|------|-------|------|------|
| BV <sub>DSS</sub>                   | Drain-Source Breakdown Voltage            | V <sub>GS</sub> =0V , I <sub>D</sub> =-250uA                        | -30  | ---   | ---  | V    |
| ΔBV <sub>DSS</sub> /ΔT <sub>J</sub> | BV <sub>DSS</sub> Temperature Coefficient | Reference to 25°C , I <sub>D</sub> =-1mA                            | ---  | -0.03 | ---  | V/°C |
| I <sub>DSS</sub>                    | Drain-Source Leakage Current              | V <sub>DS</sub> =-30V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C  | ---  | ---   | -1   | uA   |
|                                     |                                           | V <sub>DS</sub> =-24V , V <sub>GS</sub> =0V , T <sub>J</sub> =125°C | ---  | ---   | -10  | uA   |
| I <sub>GSS</sub>                    | Gate-Source Leakage Current               | V <sub>GS</sub> =±20V , V <sub>DS</sub> =0V                         | ---  | ---   | ±100 | nA   |

### On Characteristics

|                      |                                             |                                                           |      |      |      |       |
|----------------------|---------------------------------------------|-----------------------------------------------------------|------|------|------|-------|
| R <sub>DS(ON)</sub>  | Static Drain-Source On-Resistance           | V <sub>GS</sub> =-10V , I <sub>D</sub> =-8A               | ---  | 15.0 | 20   | mΩ    |
|                      |                                             | V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-5A              | ---  | 25.6 | 32   | mΩ    |
| V <sub>GS(th)</sub>  | Gate Threshold Voltage                      |                                                           | -1.0 | -1.6 | -2.5 | V     |
| ΔV <sub>GS(th)</sub> | V <sub>GS(th)</sub> Temperature Coefficient | V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =-250uA | ---  | 4    | ---  | mV/°C |
| g <sub>fs</sub>      | Forward Transconductance                    | V <sub>DS</sub> =-10V , I <sub>D</sub> =-3A               | ---  | 6.8  | ---  | S     |

### Dynamic and switching Characteristics

|                     |                                     |                                                                                           |     |      |  |    |
|---------------------|-------------------------------------|-------------------------------------------------------------------------------------------|-----|------|--|----|
| Q <sub>g</sub>      | Total Gate Charge <sup>2, 3</sup>   | V <sub>DS</sub> =-15V , V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-5A                      | --- | 11   |  | nC |
| Q <sub>gs</sub>     | Gate-Source Charge <sup>2, 3</sup>  |                                                                                           | --- | 3.4  |  |    |
| Q <sub>gd</sub>     | Gate-Drain Charge <sup>2, 3</sup>   |                                                                                           | --- | 4.2  |  |    |
| T <sub>d(on)</sub>  | Turn-On Delay Time <sup>2, 3</sup>  | V <sub>DD</sub> =-15V , V <sub>GS</sub> =-10V , R <sub>G</sub> =6Ω<br>I <sub>D</sub> =-1A | --- | 5.8  |  | ns |
| T <sub>r</sub>      | Rise Time <sup>2, 3</sup>           |                                                                                           | --- | 18.8 |  |    |
| T <sub>d(off)</sub> | Turn-Off Delay Time <sup>2, 3</sup> |                                                                                           | --- | 46.9 |  |    |
| T <sub>f</sub>      | Fall Time <sup>2, 3</sup>           |                                                                                           | --- | 12.3 |  |    |
| C <sub>iss</sub>    | Input Capacitance                   | V <sub>DS</sub> =-15V , V <sub>GS</sub> =0V , F=1MHz                                      | --- | 1250 |  | pF |
| C <sub>oss</sub>    | Output Capacitance                  |                                                                                           | --- | 160  |  |    |
| C <sub>rss</sub>    | Reverse Transfer Capacitance        |                                                                                           | --- | 90   |  |    |

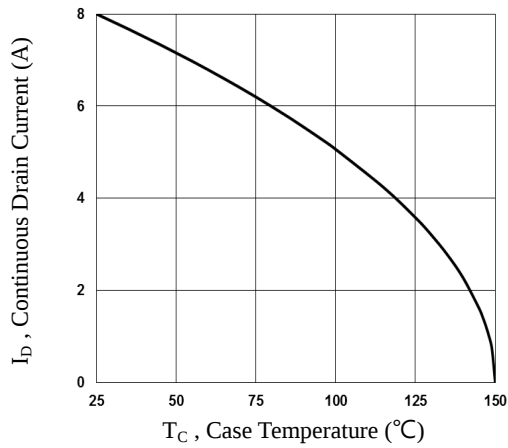
### Drain-Source Diode Characteristics and Maximum Ratings

| Symbol          | Parameter                 | Conditions                                                       | Min. | Typ. | Max. | Unit |
|-----------------|---------------------------|------------------------------------------------------------------|------|------|------|------|
| I <sub>S</sub>  | Continuous Source Current | V <sub>G</sub> =V <sub>D</sub> =0V , Force Current               | ---  | ---  | -9   | A    |
| I <sub>SM</sub> | Pulsed Source Current     |                                                                  | ---  | ---  | -16  | A    |
| V <sub>SD</sub> | Diode Forward Voltage     | V <sub>GS</sub> =0V , I <sub>S</sub> =-1A , T <sub>J</sub> =25°C | ---  | ---  | -1.3 | V    |

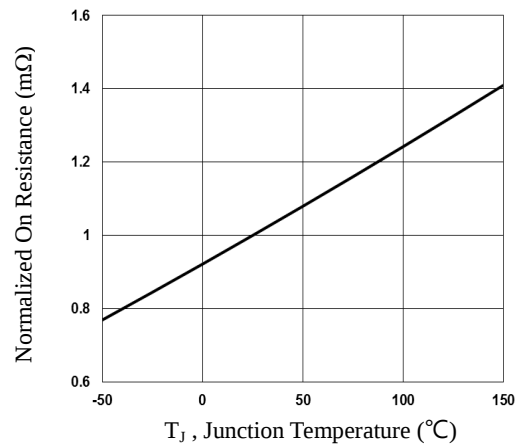
Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%.
3. Essentially independent of operating temperature.

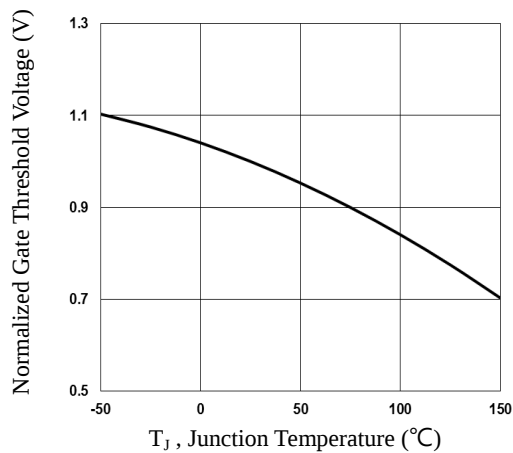
## RATING AND CHARACTERISTIC CURVES (FDS4435)



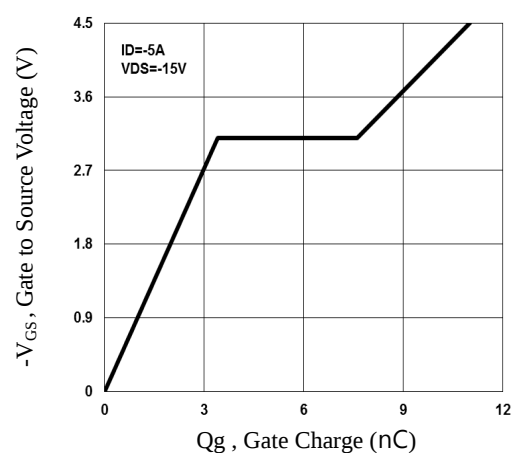
**Fig.1 Continuous Drain Current vs.  $T_C$**



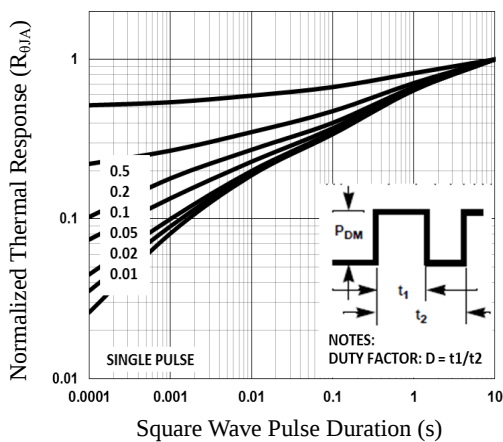
**Fig.2 Normalized  $R_{DS(on)}$  vs.  $T_J$**



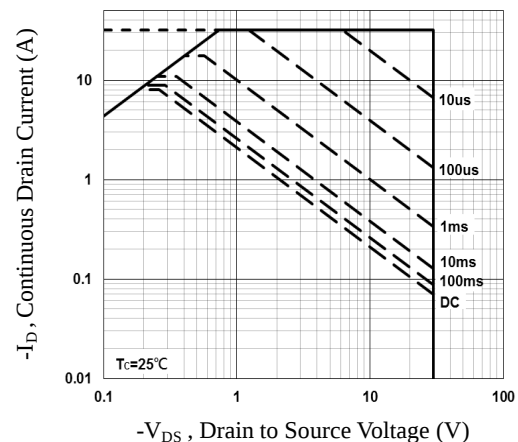
**Fig.3 Normalized  $V_{th}$  vs.  $T_J$**



**Fig.4 Gate Charge Waveform**

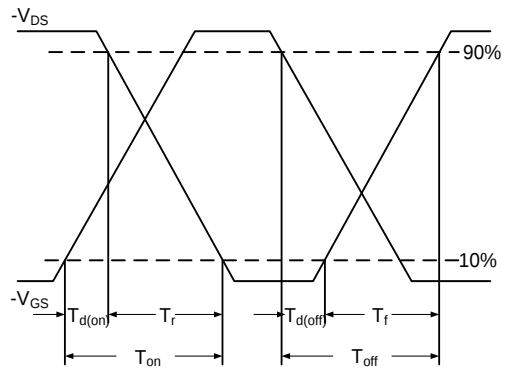


**Fig.5 Normalized Transient Impedance**

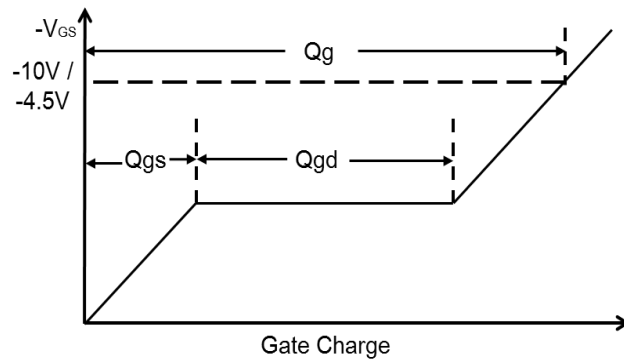


**Fig.6 Maximum Safe Operation Area**

## RATING AND CHARACTERISTIC CURVES (FDS4435)



**Fig.7 Switching Time Waveform**



**Fig.8 Gate Charge Waveform**